

IEEE 802.11 a/b/g/n/ac/ax 1T1R+BLE 5.0 IOT Module

Module: WL1NM1001
(Reolink料号:48.01.001.0074A)
(MediaTek: MT7931AN)

客户认可 Customer Approval Section		
Customer Name		
Department		
Approval		Date:

拟制 DESIGN	审核 CHECK	批准 APPROVAL
许冰	郑伟	高照
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惠州高盛达科技股份有限公司
HUIZHOU GAOSHENGDA TECHNOLOGY CO.,LTD

广东省惠州市惠澳大道惠南高新科技产业园金达路 2 号

No.2, Jin-da Road, Huinan High-tech Industrial Park, Hui-ao Avenue, Huizhou City, Guangdong Province, China



PRODUCTS SPECIFICATION

WL1NM1001

文件修订历史

版本	日期	作者	变更描述
V 1.0	2023-10-20		Draft
V 1.1	2023-10-27		Update Mechanical Dimensions and PIN definition.
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1. General Description

This document is to specify the product requirements for 802.11a/b/g/n/ac/ax and BLE5.0 1T1R IOT Module. It is based on MT7931AN low-power chipset that complied with IEEE 802.11n, and it is also backward complied with IEEE 802.11b/g standard from 2.4~2.5GHz. It is also backward complied with IEEE 802.11a standard from 5.15~5.825GHz wideband and IEEE 802.11b/g standard from 2.4~2.5GHz. It can be used to provide up to 54Mbps for IEEE 802.11a and IEEE 802.11g, 11Mbps for IEEE 802.11b and 72.2Mbps for IEEE802.11n. The BLE part supports latest 5.0

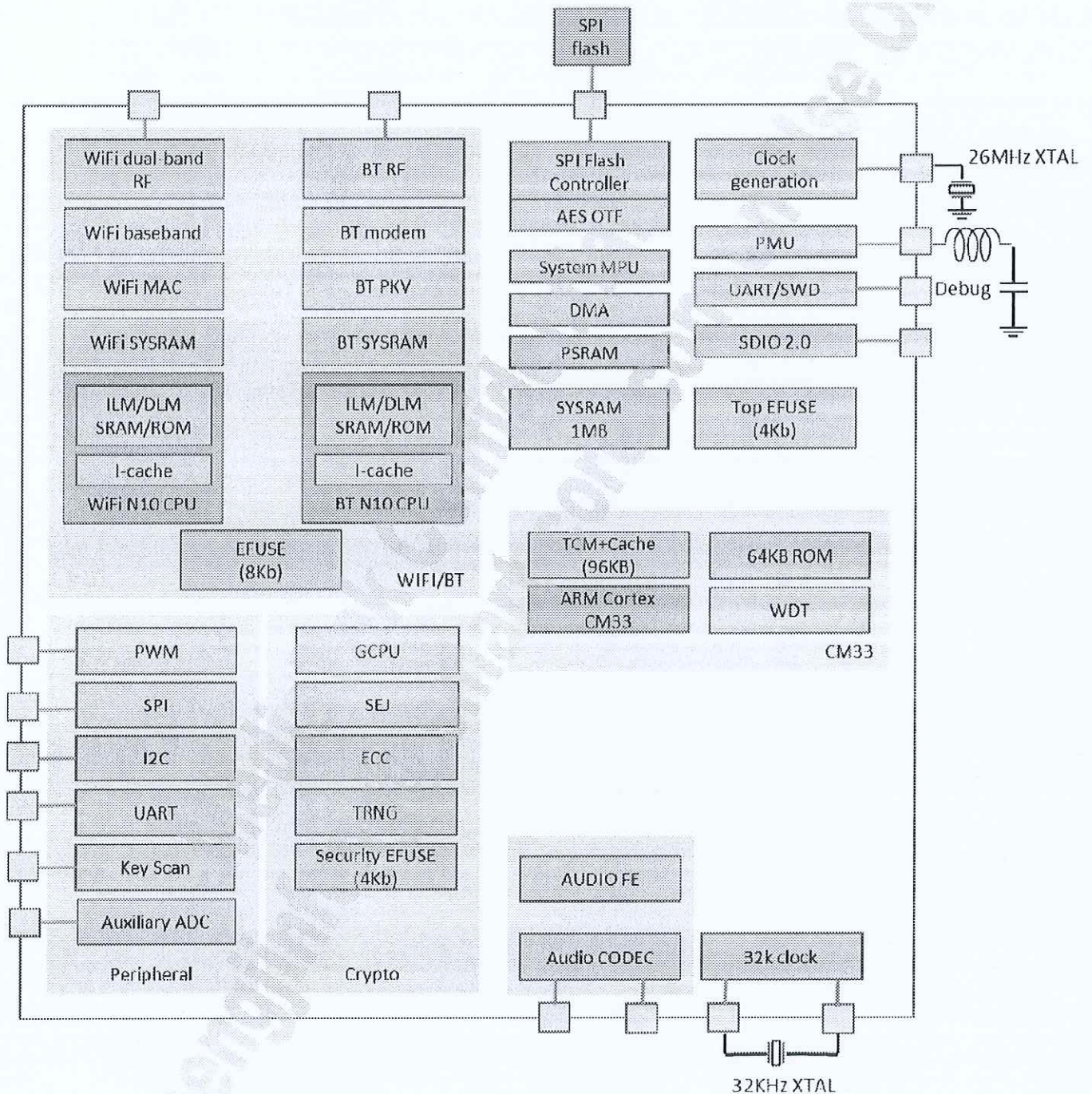
The MT7931AN is a highly integrated single chip that features an ARM® Cortex-M33 application processor, a low power 1x1 802.11a/b/g/n/ac/ax dual-band Wi-Fi subsystem, a Bluetooth v5.0 subsystem and a Power Management Unit (PMU). The Wi-Fi subsystem and a Bluetooth v5.0 subsystem offer feature-rich wireless connectivity at high standards, and deliver reliable, cost-effective throughput from an extended distance. Optimized RF architecture and baseband algorithms provide superb performance and low power consumption. The MT7931AN is designed to support standard based features in the areas of security, quality of service and international regulations, giving end users the greatest performance any time and in any circumstance. The MT7931AN is based on ARM® Cortex-M33 with floating point microcontroller (MCU) including SRAM/ROM memory. The chip also supports rich peripheral interfaces, including SDIO, SPI master, I2C, I2S, IR input, UART, AUXADC, PWM, and GPIOs.

2. Features

- Support IEEE 802.11 a/b/g/n/ac/ax+BLE5.0
- Supports 1x1 20MHz bandwidth, MCS0~8(256-QAM) in 2.4/5 GHz band
- Support uplink MU-OFDMA TX and downlink MU-OFDMA RX
- Embedded 4MB pSRAM for applications
- Support BT5.0 2M_PHY/Long Range/Advertising Extension/SAM/CS#2/High Duty Cycle Non-Connectable ADV
- Wi-Fi security WPA WPA2/WPA3 personal, WPS2.0
- Support WiFi and BT co-existence
- Rich peripherals such as SDIO, SPI master, I2C, I2S, IR input, UART, AUXADC, PWM, and GPIOs
- HSF

3. Application Diagrams

3.1 Functional Block Diagram



3.2 General Requirements

3.2.1 IEEE 802.11b Section

	Feature	Detailed Description
3.2.1.1	Standard	IEEE 802.11b
3.2.1.2	Radio and Modulation Schemes	DQPSK , DBPSK and CCK with DSSS
3.2.1.3	Operating Frequency	2400 ~ 2483.5MHz ISM band
3.2.1.4	Channel Numbers	13 channels for Worldwide
3.2.1.5	Data Rate	at most 11Mbps
3.2.1.6	Media Access Protocol	CSMA/CA with ACK
3.2.1.7	Transmitter Output Power at Antenna Connector	- Typical RF Output Power at each RF chain, and at room Temp. 25°C 16±2 dBm at 11Mbps
3.2.1.8	Receiver Sensitivity at Antenna Connector	- Typical Sensitivity at each RF chain. @Frame (1000-byte PDUs) Error Rate<8% at room Temp. 25°C -83 dBm for 11Mbps

3.2.2 IEEE 802.11g Section

	Feature	Detailed Description
3.2.2.1	Standard	IEEE 802.11g
3.2.2.2	Radio and Modulation Type	QPSK , BPSK , 16QAM ,64QAM with OFDM
3.2.2.3	Operating Frequency	2400 ~ 2483.5MHz ISM band
3.2.2.4	Channel Numbers	13 channels for Worldwide
3.2.2.5	Data Rate	at most 54Mbps
3.2.2.6	Media Access Protocol	CSMA/CA with ACK
3.2.2.7	Transmitter Output Power at Antenna Connector	- Typical RF Output Power at each RF chain, at room Temp. 25°C 14±2 dBm at 54Mbps
3.2.2.8	Receiver Sensitivity at Antenna Connector	- Typical Sensitivity at each RF chain. @Frame (1000-byte PDUs) Error Rate<10% at room Temp. 25°C -70 dBm for 54Mbps

3.2.3 IEEE 802.11a Section

	Feature	Detailed Description
3.2.3.1	Standard	IEEE 802.11a
3.2.3.2	Radio and Modulation Type	QPSK , BPSK , 16QAM ,64QAM with OFDM
3.2.3.3	Operating Frequency	5.15~5.25GHz 5.25~5.35GHz 5.47~5.725GHz 5.725~5.825GHz
3.2.3.4	Data Rate	at most 54Mbps
3.2.3.5	Media Access Protocol	CSMA/CA with ACK
3.2.3.6	Transmitter Output Power at Antenna Connector	- Typical RF Output Power at each RF chain,at room Temp. 25°C 14±2 dBm at 54Mbps
3.2.3.7	Receiver Sensitivity at Antenna Connector	- Typical Sensitivity at each RF chain. @Frame (1000-byte PDUs) Error Rate<10% at room Temp. 25°C -70 dBm for 54Mbps

3.2.4 IEEE 802.11n Section

	Feature	Detailed Description
3.2.4.1	Standard	IEEE 802.11n
3.2.4.2	Radio and Modulation Type	BPSK , QPSK , 16QAM ,64QAM with OFDM
3.2.4.3	Operating Frequency	2.4GHz :2400 ~ 2483.5MHz for ISM band 5GHz : 5.15~5.25GHz; 5.25~5.35GHz; 5.47~5.725GHz; 5.725~5.825GHz;
3.2.4.4	Data Rate	at most 72.2 Mbps
3.2.4.5	Media Access Protocol	CSMA/CA with ACK
3.2.4.6	Transmitter Output Power at Antenna Connector	- Typical RF Output Power at each RF chain, at room Temp. 25°C 2.4GHz Band/HT20 13±2dBm at MCS7 5GHz Band/HT20 13±2dBm at MCS7
3.2.4.7	Receiver Sensitivity at Antenna Connector	- Typical Sensitivity at each RF chain. @Frame(1000-byte PDUs)Error Rate=10% and at room Temp. 25°C 2.4GHz Band/HT20 -68dBm at MCS7 5GHz Band/HT20 -68dBmat MCS7

3.2.5 IEEE 802.11ac Section

	Feature	Detailed Description
3.2.5.1	Standard	IEEE 802.11ac
3.2.5.2	Radio and Modulation Type	QPSK , BPSK , 16QAM ,64QAM,256QAM with OFDM
3.2.5.3	Operating Frequency	5GHz : 5.15~5.25GHz; 5.25~5.35GHz; 5.47~5.725GHz; 5.725~5.825GHz;
3.2.5.4	Data Rate	at most 86.6 Mbps
3.2.5.5	Media Access Protocol	CSMA/CA with ACK
3.2.5.6	Transmitter Output Power at Antenna Connector	- Typical RF Output Power at each RF chain, at room Temp. 25°C 13±2dBm VHT20
3.2.5.7	Receiver Sensitivity at Antenna Connector	- Typical Sensitivity at each RF chain. @Frame(1000-byte PDUs)Error Rate<10% at room Temp. 25°C 5GHz Band/VHT20 -64dBm at MCS8

3.2.6 IEEE 802.11ax Section

	Feature	Detailed Description
3.2.6.1	Standard	IEEE 802.11ax
3.2.6.2	Radio and Modulation Type	QPSK , BPSK , 16QAM ,64QAM,256QAM, 1024QAM with OFDM
3.2.6.3	Operating Frequency	2G: 2400 ~ 2483.5MHz ISM band 5GHz : 5.15~5.25GHz; 5.25~5.35GHz; 5.47~5.725GHz; 5.725~5.825GHz;
3.2.6.4	Data Rate	at most 103.2Mbps
3.2.6.5	Media Access Protocol	CSMA/CA with ACK
3.2.6.6	Transmitter Output Power at Antenna Connector	- Typical RF Output Power at each RF chain, at room Temp 25°C 2.4GHz Band/HE20 12±2dBm 5GHz Band/HE20 12±2dBm
3.2.6.7	Receiver Sensitivity at Antenna Connector	- Typical Sensitivity at each RF chain. @Frame(1000-byte PDUs)Error Rate<10% at room Temp. 25°C 2GHz Band/HE20 -57dBm at MCS8 5GHz Band/HE20 -57dBm at MCS8

3.2.7 Bluetooth Section

Feather		Description	
General specification			
Bluetooth standard	BluetoothLE V5.0		
Frequency band	2402MHz-2480MHz		
Channel Numbers	40 channels for BLE		
RF specification			
	Min (dBm)	Type (dBm)	Max (dBm)
BLE Output Power		5	
Sensitive @PER=30.8% FOR BLE		-90	

4. Electrical and Thermal Characteristics

4.1 Temperature Limit Ratings

Parameter	Minimum	Maximum	Units
Storage Temperature	-40	+125	°C
Ambient Operating Temperature	-30	+125	°C

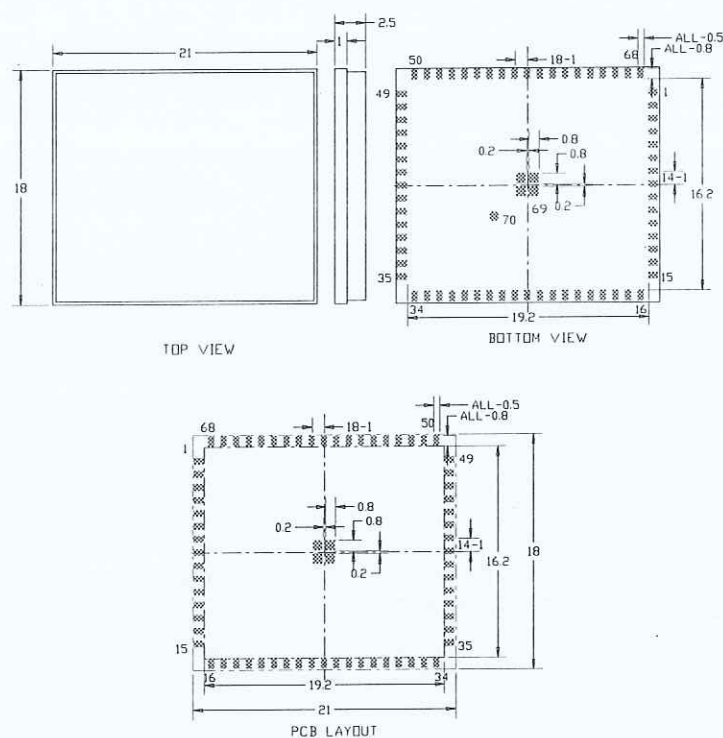
4.2 General Section

	Feature	Detailed Description
4.2.1	Antenna Type	PAD
4.2.2	Operating Voltage	3.3V±10%
4.2.3	Current Consumption	< 100mA@RX < 800mA@TX

4.3 Mechanical Requirements

	Feature	Detailed Description
4.3.1	Length	21mm
4.3.2	Width	18mm
4.3.3	Height	1.0mm(PCB)

5. Mechanical Dimensions



尺寸误差范围:

DIM (MM)	Tolerance (MM)
0-5	±0.15
5-10	±0.20
10-50	±0.30

6. Pin define

Pin	Name	Description	Pin	Name	Description
1	VDD33_RTC	32K Clock 3.3V power	29	GND	GND
2	GND	GND	30	GND	GND
3	VDDIO	Digital IO power	31	GND	GND
4	GND	GND	32	VDD33	Input power 3.3V
5	GND	GND	33	VDD33	Input power 3.3V
6	GND	GND	34	GND	GND
7	SDIO_D1	SDIO_DAT1	35	MICBIAS	CODEC_ADC ADC0 MICBIAS OUTPUT
8	SDIO_D0	SDIO_DAT0	36	GND	GND
9	GND	GND	37	AU_VIN1_N	CODEC_ADC ADC1 RCH N_port input
10	SDIO_CLK	SDIO_CLK	38	AU_VIN1_P	CODEC_ADC ADC1 RCH P_port input
11	GND	GND	39	GND	GND
12	SDIO_CMD	SDIO_CMD	40	AU_VIN0_N	CODEC_ADC ADC0 LCH N_port input
13	SDIO_D3	SDIO_DAT3	41	AU_VIN0_P	CODEC_ADC ADC0 LCH P_port input
14	SDIO_D2	SDIO_DAT2	42	GND	GND
15	GND	GND	43	AU_VOLP	CODEC_DAC Left_chanel P_port output signal
16	RST	RESET	44	AU_VORP	CODEC_DAC Right_chanel P_port output signal
17	GPIO_B_0	GPIO12	45	GND	GND
18	GPIO_B_10	GPIO22	46	GPIO_T_1	GPIO42
19	GPIO_B_12	GPIO24	47	GPIO_T_3	GPIO44
20	GPIO_B_2	GPIO14	48	KPROW_1	GPIO48
21	GPIO_B_4	GPIO16	49	KPCOL_0	GPIO50
22	GPIO_B_3	GPIO15	50	GND	GND
23	GPIO_B_5	GPIO17	51	NC/BT_RF	Option. 需要BT单独一路天线时可选此pin
24	GPIO_B_6	GPIO18	52	GND	GND
25	GPIO_B_7	GPIO19	53	NC	NC
26	GPIO_B_8	GPIO20	54	GND	GND
27	GPIO_B_9	GPIO21	55	GND	GND
28	GPIO_B_11	GPIO23	56	GND	GND



PRODUCTS SPECIFICATION

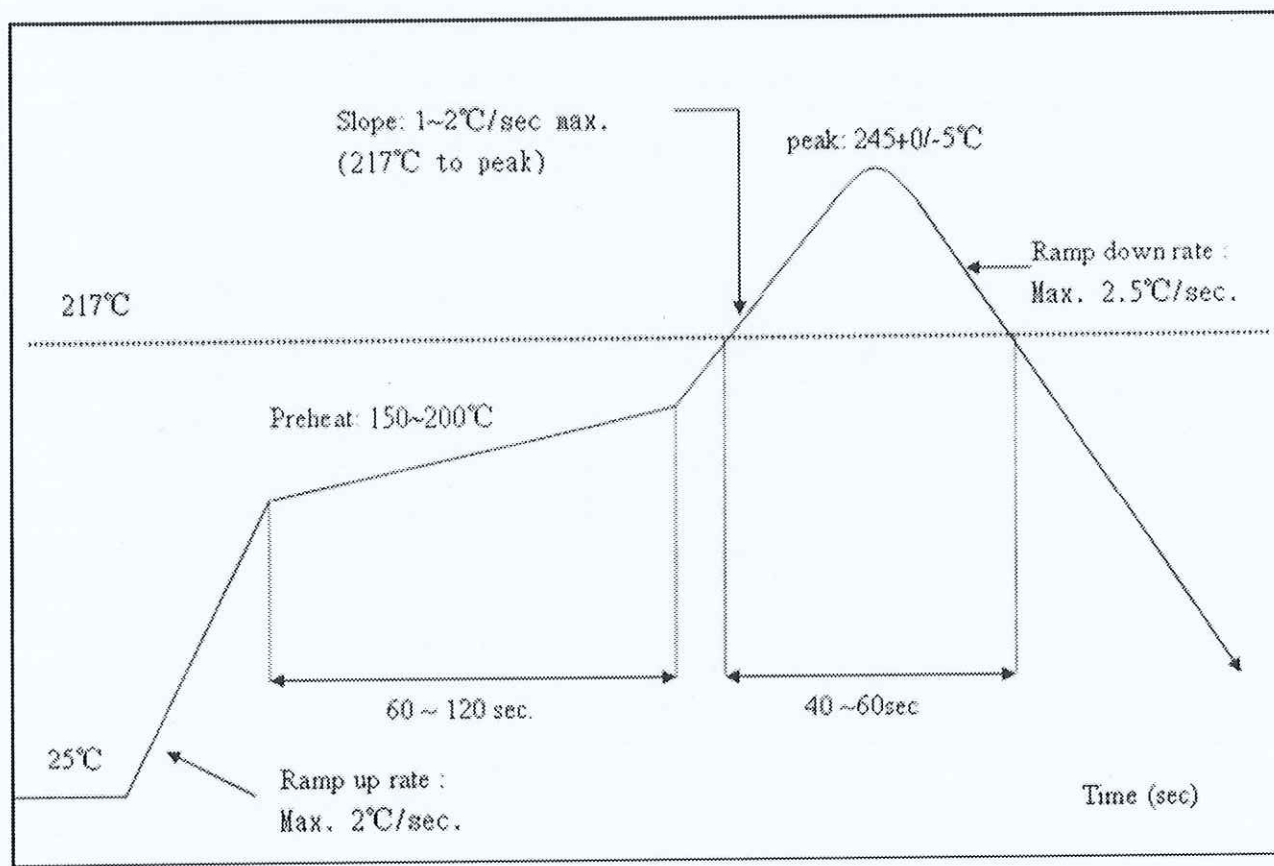
WL1NM1001

Pin	Name	Description	Pin	Name	Description
57	GND	GND	63	GND	GND
58	GND	GND	64	GND	GND
59	GND	GND	65	GND	GND
60	GND	GND	66	GND	GND
61	GND	GND	67	WIFI_RF	WIFI_RF
62	GND	GND	68	GND	GND

7. DC Characteristics (VDDIO=3.3V)

名称	参数	最小值	TYPE	最大值	单位
V_{IL}	低电平输入	-0.3		$0.25 \cdot V_{DD3.3}$	V
V_{IH}	高电平输入	$0.625 \cdot V_{DD3.3}$		3.63	V
V_{OL}	低电平输出	-0.3		0.45	V
V_{OH}	高电平输出	$V_{DD3.3} - 0.45$		$V_{DD3.3} + 0.3$	V

8. Recommended Reflow Profile



参考 IPC/JEDEC 标准. 峰值温度 : 245±5° C Times : ≤2 s

Appendix1 : Important material information

	名称	厂家	使用状态
1	集成电路	MTK	在用
2	贴片电容	太诱/三星/村田/华新科/风华	在用
3	贴片电感	村田/风华/奇立新	在用
4	贴片电阻	国巨/大毅/华新科/旺诠	在用
5	贴片晶振	晶宝时频/晶威特/东晶/创捷/长兴/TXC/加高	在用
6	功率电感	风华/奇立新/佳邦/顺络/村田	在用
7	FLASH	Winbond/芯天下/GigaDevice/恒烁	在用
8	印制板	富智祥/宝信欣旺/凌航达/百联承/永源隆/三强/科翔	在用

Requirement per KDB996369 D03

2.2 List of applicable FCC rules

List the FCC rules that are applicable to the modular transmitter. These are the rules that specifically establish the bands of operation, the power, spurious emissions, and operating fundamental frequencies. DO NOT list compliance to unintentional-radiator rules (Part 15 Subpart B) since that is not a condition of a module grant that is extended to a host manufacturer. See also Section 2.10 below concerning the need to notify host manufacturers that further testing is required.³

Explanation: This module meets the requirements of FCC part 15C(15.247).

2.3 Summarize the specific operational use conditions

Describe use conditions that are applicable to the modular transmitter, including for example any limits on antennas, etc. For example, if point-to-point antennas are used that require reduction in power or compensation for cable loss, then this information must be in the instructions. If the use condition limitations extend to professional users, then instructions must state that this information also extends to the host manufacturer's instruction manual. In addition, certain information may also be needed, such as peak gain per frequency band and minimum gain, specifically for master devices in 5 GHz DFS bands.

Explanation: The EUT has a FPC or Dipole Antenna, The antenna is the unique connector with a wire antenna.

2.4 Limited module procedures

If a modular transmitter is approved as a "limited module," then the module manufacturer is responsible for approving the host environment that the limited module is used with. The manufacturer of a limited module must describe, both in the filing and in the installation instructions, the alternative means that the limited module manufacturer uses to verify that the host meets the necessary requirements to satisfy the module limiting conditions.

A limited module manufacturer has the flexibility to define its alternative method to address the conditions that limit the initial approval, such as: shielding, minimum signaling amplitude, buffered modulation/data inputs, or power supply regulation. The alternative method could include that the limited module manufacturer reviews detailed test data or host designs prior to giving the host manufacturer approval.

This limited module procedure is also applicable for RF exposure evaluation when it is necessary to demonstrate compliance in a specific host. The module manufacturer must state how control of the product into which the modular transmitter will be installed will be maintained such that full compliance of the product is always ensured. For additional hosts other than the specific host originally granted with a limited module, a Class II permissive change is required on the module grant to register the additional host as a specific host also approved with the module.

Explanation: The module is not a limited module.

2.5 Trace antenna designs

For a modular transmitter with trace antenna designs, see the guidance in Question 11 of KDB Publication 996369 D02 FAQ – Modules for Micro-Strip Antennas and traces. The integration information shall include for the TCB review the integration instructions for the following aspects:

layout of trace design, parts list (BOM), antenna, connectors, and isolation requirements.

- a) Information that includes permitted variances (e.g., trace boundary limits, thickness, length, width, shape(s), dielectric constant, and impedance as applicable for each type of antenna);
- b) Each design shall be considered a different type (e.g., antenna length in multiple(s) of frequency, the wavelength, and antenna shape (traces in phase) can affect antenna gain and must be considered);
- c) The parameters shall be provided in a manner permitting host manufacturers to design the printed circuit (PC) board layout;
- d) Appropriate parts by manufacturer and specifications;
- e) Test procedures for design verification; and
- f) Production test procedures for ensuring compliance.

The module grantee shall provide a notice that any deviation(s) from the defined parameters of the antenna trace, as described by the instructions, require that the host product manufacturer must notify the module grantee that they wish to change the antenna trace design. In this case, a Class II permissive change application is required to be filed by the grantee, or the host manufacturer can take responsibility through the change in FCC ID (new application) procedure followed by a Class II permissive change application.

Explanation: The antenna of this product is not a printed antenna, It's an FPC or Dipole antenna

2.6 RF exposure considerations

It is essential for module grantees to clearly and explicitly state the RF exposure conditions that permit a host product manufacturer to use the module. Two types of instructions are required for RF exposure information: (1) to the host product manufacturer, to define the application conditions (mobile, portable – xx cm from a person's body); and (2) additional text needed for the host product manufacturer to provide to end users in their end-product manuals. If RF exposure statements and use conditions are not provided, then the host product manufacturer is required to take responsibility of the module through a change in FCC ID (new application).

Explanation: This module complies with FCC RF radiation exposure limits set forth for an uncontrolled environment, This equipment should be installed and operated with a minimum distance of 20 centimeters between the radiator and your body." This module is designed to comply with the FCC statement, FCC ID is:

2BN5S-2503H

2.7 Antennas

A list of antennas included in the application for certification must be provided in the instructions. For modular transmitters approved as limited modules, all applicable professional installer instructions must be included as part of the information to the host product manufacturer. The antenna list shall also identify the antenna types (monopole, PIFA, dipole, etc. (note that for example an “omni-directional antenna” is not considered to be a specific “antenna type”)).

For situations where the host product manufacturer is responsible for an external connector, for example with an RF pin and antenna trace design, the integration instructions shall inform the installer that unique antenna connector must be used on the Part 15 authorized transmitters used in the host product. The module manufacturers shall provide a list of acceptable unique connectors.

Explanation: The EUT has an FPC or Dipole antenna and uses a unique antenna connector

2.8 Label and compliance information

Grantees are responsible for the continued compliance of their modules to the FCC rules. This includes advising host product manufacturers that they need to provide a physical or e-label stating “Contains FCC ID” with their finished product. See Guidelines for Labeling and User Information for RF Devices – KDB Publication 784748.

Explanation: The host system using this module, should have label in a visible area indicated the following texts: “Contains FCC ID: 2BN5S-2503H”

2.9 Information on test modes and additional testing requirements⁵

Additional guidance for testing host products is given in KDB Publication 996369 D04 Module Integration Guide. Test modes should take into consideration different operational conditions for a stand-alone modular transmitter in a host, as well as for multiple simultaneously transmitting modules or other transmitters in a host product.

The grantee should provide information on how to configure test modes for host product evaluation for different operational conditions for a stand-alone modular transmitter in a host, versus with multiple, simultaneously transmitting modules or other transmitters in a host.

Grantees can increase the utility of their modular transmitters by providing special means, modes, or instructions that simulates or characterizes a connection by enabling a transmitter. This can greatly simplify a host manufacturer’s determination that a module as installed in a host complies with FCC requirements.

Explanation: Top band can increase the utility of our modular transmitters by providing instructions that simulates or characterizes a connection by enabling a transmitter.

2.10 Additional testing, Part 15 Subpart B disclaimer

The grantee should include a statement that the modular transmitter is only FCC authorized for the specific rule parts (i.e., FCC transmitter rules) listed on the grant, and that the host product manufacturer is responsible for compliance to any other FCC rules that apply to the host not covered by the modular transmitter grant of certification. If the grantee markets their product as being Part 15 Subpart B compliant (when it also contains unintentional-radiator digital circuitry), then the grantee shall provide a notice stating that the final host product still requires Part 15 Subpart B compliance testing with the modular transmitter installed.

Explanation: The module without unintentional-radiator digital circuitry, so the module does not require an evaluation by FCC Part 15 Subpart B. The host should be evaluated by the FCC Subpart B.

FCC STATEMENT :

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference, and
- (2) This device must accept any interference received, including interference that may cause undesired operation.

Warning: Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Radiation Exposure Statement:

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.

The OEM must certify the final end product to comply with unintentional radiators (FCC Sections 15.107 and 15.109) before declaring compliance of the final product to Part 15 of the FCC rules and regulations. Integration into devices that are directly or indirectly connected to AC lines must add with Class II Permissive Change.

The OEM must comply with the FCC labeling requirements. If the module's label is not visible when installed, then an additional permanent label must be applied on the outside of the finished product which states: "Contains transmitter module FCC ID: 2BN5S-2503H". Additionally, the following statement should be included on the label and in the final product's user manual:

"This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interferences, and
- (2) this device must accept any interference received, including interference that may cause undesired operation."

The module is limited to installation in mobile or fixed applications. Separate approval is required for all other operating configurations, including portable configuration with respect to Part 2.1093 and different antenna configurations.

A module or modules can only be used without additional authorizations if they have been tested and granted under the same intended end - use operational conditions, including simultaneous transmission operations.

When they have not been tested and granted in this manner, additional testing and/or FCC application filing may be required. The most straightforward approach to address additional testing conditions is to have the grantee responsible for the certification of at least one of the modules submit a permissive change application.

When having a module grantee file a permissive change is not practical or feasible, the following guidance provides some additional options for host manufacturers. Integrations using modules where additional testing and/or FCC application filing(s) may be required are: (A) a module used in devices requiring additional RF exposure compliance information (e.g., MPE evaluation or SAR testing); (B) limited and/or split modules not meeting all of the module requirements; and (C) simultaneous transmissions for independent collocated transmitters not previously granted together.

This Module is full modular approval, it is limited to OEM installation ONLY.

Integration into devices that are directly or indirectly connected to AC lines must add with Class II Permissive Change. (OEM) Integrator has to assure compliance of the entire end product include the integrated Module. Additional measurements (15B) and/or equipment authorizations (e.g. Verification) may need to be addressed depending on co-location or simultaneous transmission issues if applicable. (OEM) Integrator is reminded to assure that these installation instructions will not be made available to the end user

IC labeling requirement for the final end product:

The final end product must be labeled in a visible area with the following “Contains IC: 33667-2503H”

The Host Marketing Name (HMN) must be indicated at any location on the exterior of the host product or product packaging or product literature, which shall be available with the host product or online.

This radio transmitter [IC:33667-2503H] has been approved by Innovation, Science and Economic Development Canada to operate with the antenna types listed below, with the maximum permissible gain indicated. Antenna types not included in this list that have a gain greater than the maximum gain indicated for any type listed are strictly prohibited for use with this device.

Antenna Manufacturer	Antenna Name	Model	Antenna Type	Antenna Gain (BLE /WIFI 2.4G)	Antenna Gain (WIFI 5G)
SHENZHEN LINRONG TECHNOLOGY CO., LTD	Argus 4 Pro Argus 4	03.10.03.003	FPC Antenna	3.3 dBi	2.8 dBi
SHENZHEN YINGJIACHUANG ELECTRONIC TECHNOLOGY CO. LTD.	Argus PT Ultra@Reolink Argus PT	54.07.001.0147	Dipole Antenna	2.89 dBi	2.32 dBi
Shenzhen Be-Comfortable Technology Co. Ltd	Reolink Altas PT Ultra	53.05.004.0014	Dipole Antenna	4.4dBi	3.42dBi
SHENZHEN LINRONG TECHNOLOGY CO., LTD	Reolink Altas	03.14.03.001	Dipole Antenna	3.81dBi	3.17dBi
Shenzhen Be-Comfortable Technology Co. Ltd	Reolink TrackMix	62.04.042.0055	Dipole Antenna	3.05 dBi	4.5 dBi

This device complies with CAN ICES-3 (B)/NMB-3(B)

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions:

- (1) This device may not cause interference, and
- (2) This device must accept any interference, including interference that may cause undesired operation of the device.

Cet appareil est conforme à la norme CAN ICES-3 (B)/NMB-3 (B)

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes:

- (1) l'appareil ne doit pas produire de brouillage, et
- (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement

RF exposure statement

The equipment complies with IC Radiation exposure limit set forth for uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator and your body.

L'équipement respecte la limite d'exposition aux rayonnements IC fixée pour un environnement non contrôlé. Cet équipement doit être installé et utilisé avec une distance minimale de 20 cm entre le radiateur et votre corps.